

Description

The BDH8181 is an integrated Hall-effect latched sensor designed for electronic commutation of brushless DC motor applications.

The device includes an on-chip Hall voltage generator for magnetic sensing, a comparator that amplifiers the Hall voltage, and a Schmitt to provide switching hysteresis for noise rejection and open -collector output.

An internal bandgap regulator is used to provide temperature compensated supply voltage for internal circuits and allows a wide operating supply range.

A north pole of sufficient strength will turn the output ON. In the absence of a magnetic field, the output is OFF.

This IC is available in TO-92S-3 and SOT-23-3 package.

Features

- On-chip Hall Sensor
- Wide Operating Voltage Range: 3.5V to 24V
- Internal Bandgap Regulator for Temperature Compensation
- Maximum Output Sink Current: 25mA
- Operating Temperature: -40°C to 125°C
- ESD Rating: 3000V (Human Body Model) 300V (Machine Model)

Application

Brushless DC Motor

Functional Block Diagram

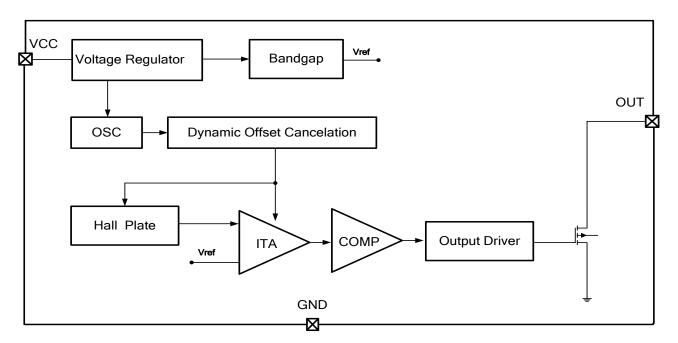


Figure 1. Functional Block Diagram of BDH8181

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Test Circuit

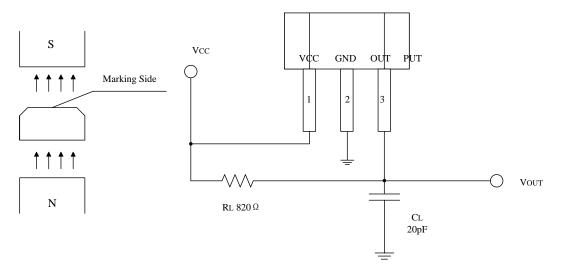


Figure 2. Basic Test Circuit of BDH8181

Package Information

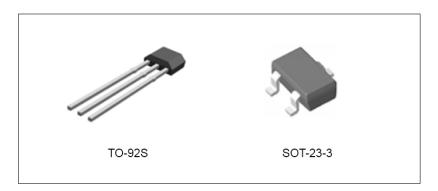


Figure 3. Package Type of BDH8181

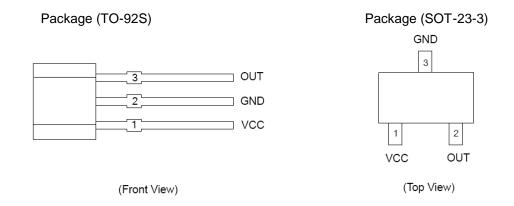


Figure 4. Pin Configuration of BDH8181



Pin Description

Pin I	Number	Name	Formation
TO-92S	SOT23-3L	Name	Function
1	1	VCC	Supply voltage
2	3	GND	Ground pin
3	2	OUT	Output

Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Value	Unit
Supply Voltage	Vcc	-5 to 30	V
Output Off Voltage	Vce	30	V
Output Sink Current (Continuous Current)	Іоит	25	mA
Power Dissipation	PD	400	mW
Storage Temperature	Ts	-55 to 150	°C
Junction Temperature	TJ	125	°C
ESD (Machine Model)	ESD	300	V
ESD (Human Body Model)	ESD	4000	V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions (TA=25°C)

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	3.5	24	V
Operating Temperature	Тор	-40	125	°C

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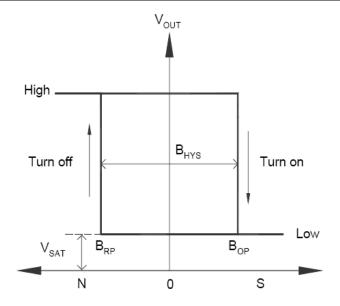
Electrical Characteristics

VCC =12V, TA =25°C, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Туре	Max	Unit
Supply Voltage	Vcc	Operating	3.5		24	V
Supply Current	Icc	Awake		2.5	5	mA
Output Leakage Current	ILEAK	B< BRP		<0.1	10	μA
Output Saturation Voltage	Vsat	IOUT =1.0mA		110	300	mV
Rise Time	tr	Operating		0.2		μs
Fall Time	Tf	Operating		0.2		μs

Magnetic Characteristics (TA=25°C)

Parameter	Symbol	Min	Туре	Max	Unit
Operating point	Вор	-	20	50	Gauss
Releasing Point	B _{RP}	-50	-20	-	Gauss
Hysteresis	Внуѕ		40		Gauss



Magnetic Flux Density (Gauss)

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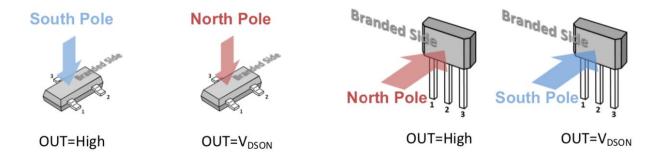
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Parameter	Symbol	Min	Туре	Max	Unit
Operating point	Вор	-	20	50	Gauss
Releasing Point	B _{RP}	-50	-20	-	Gauss
Hysteresis	Внуѕ		40		Gauss

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Definition of Switching Function

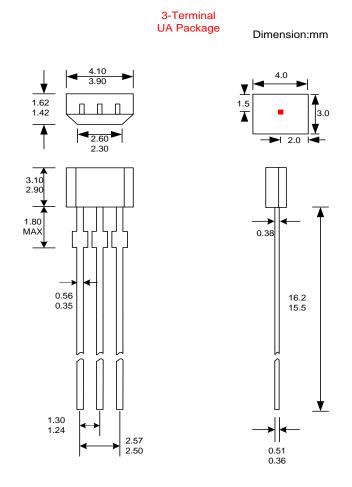


Switching Point of SOT-23-3

Switching Point of TO-92S

Package Dimensions

1.TO-92S



Notes:

- 1. Exact body and lead configuration at vendor's option within limits shown.
- 2. Height does not include mold gate flash.

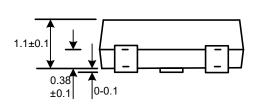
Where no tolerance is specified, dimension is nominal.

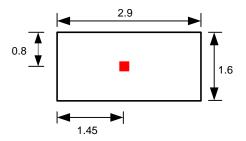


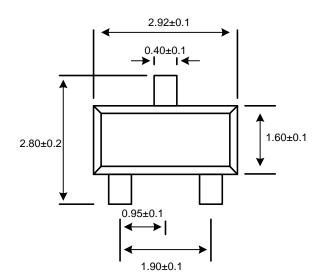
2、SOT-23-3

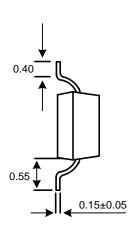
3-Terminal SO Package

Dimension:mm









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